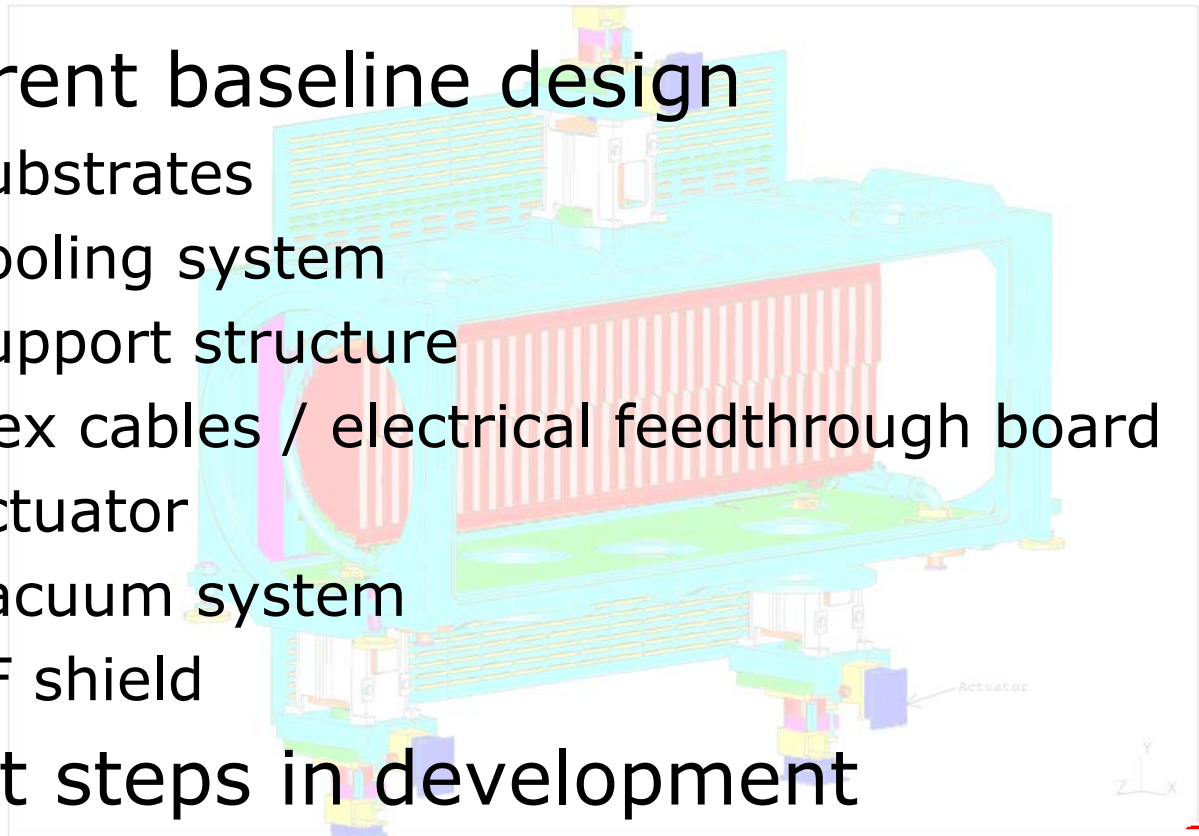
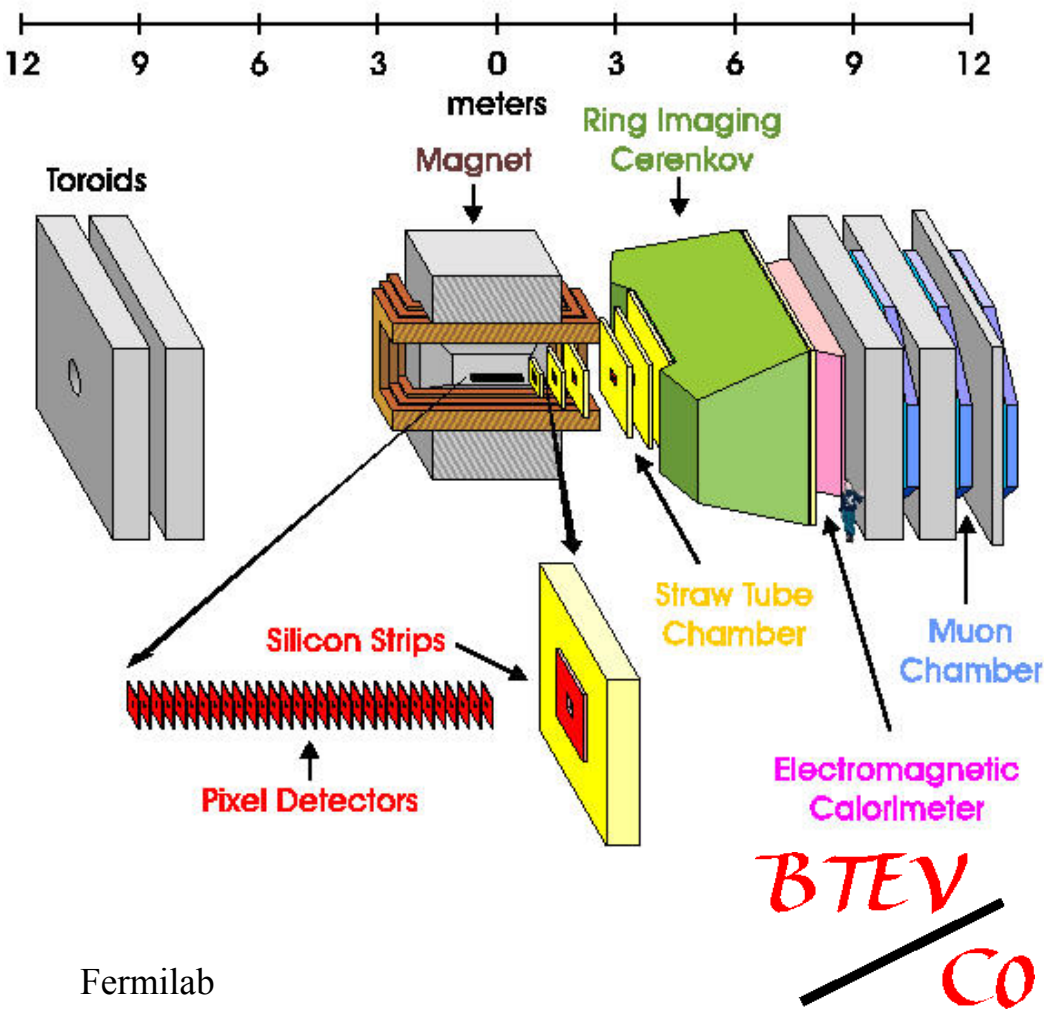
# BTeV Silicon Detector Integration Issues



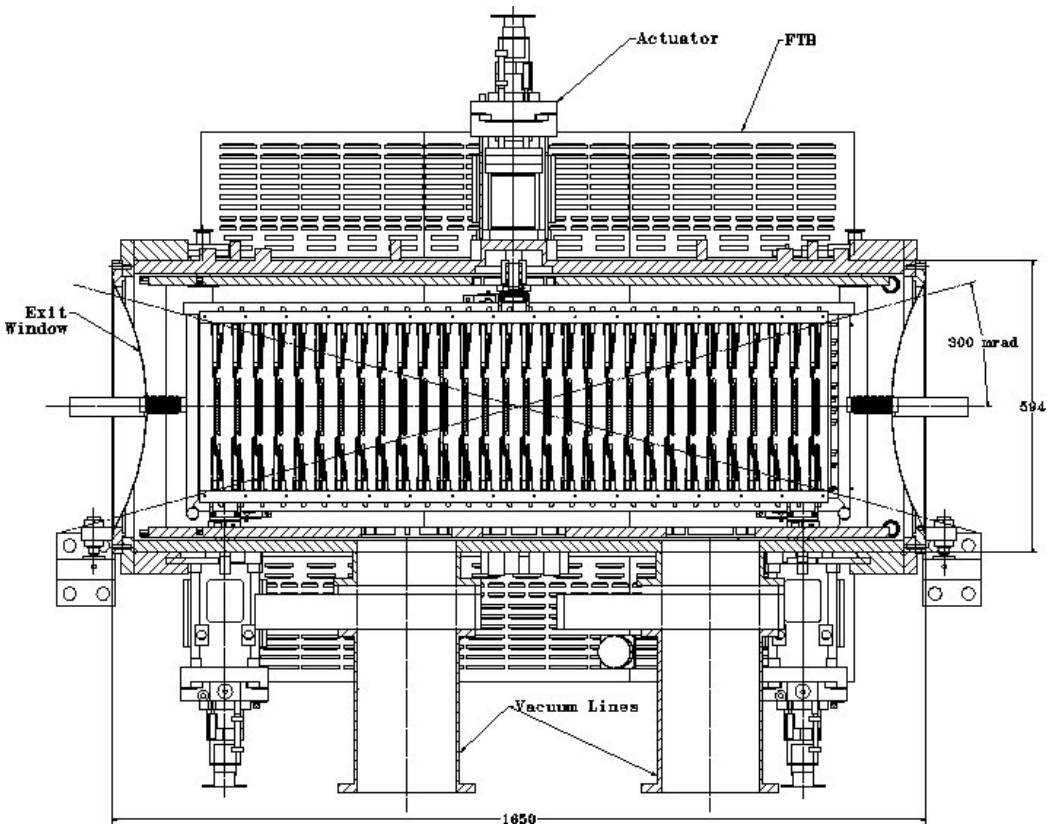
- Current baseline design
  - Substrates
  - Cooling system
  - Support structure
  - Flex cables / electrical feedthrough board
  - Actuator
  - Vacuum system
  - RF shield
- Next steps in development

# BTeV Silicon Detector Technical Requirements

- 3000 electrical cables
- Heat load each readout chip 0.5 W/cm$^2$, total detector load 2.5 kW
- Operational temperature –5°C to –10°C, reproducible +/-2°C
- Pixels reside in beam vacuum ($10^{-7}$ torr)
- Sits within analysis magnet with field 1.6 T



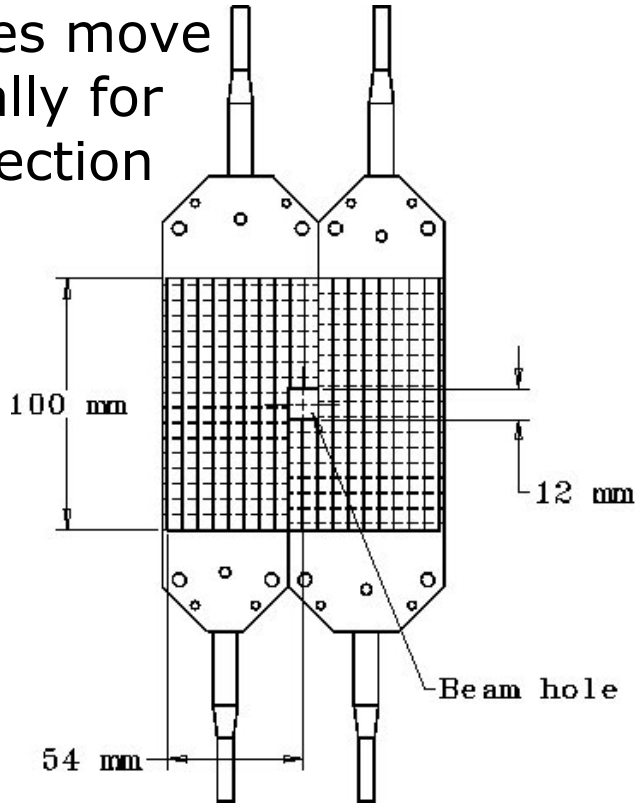
# Technical Requirements (cont'd)

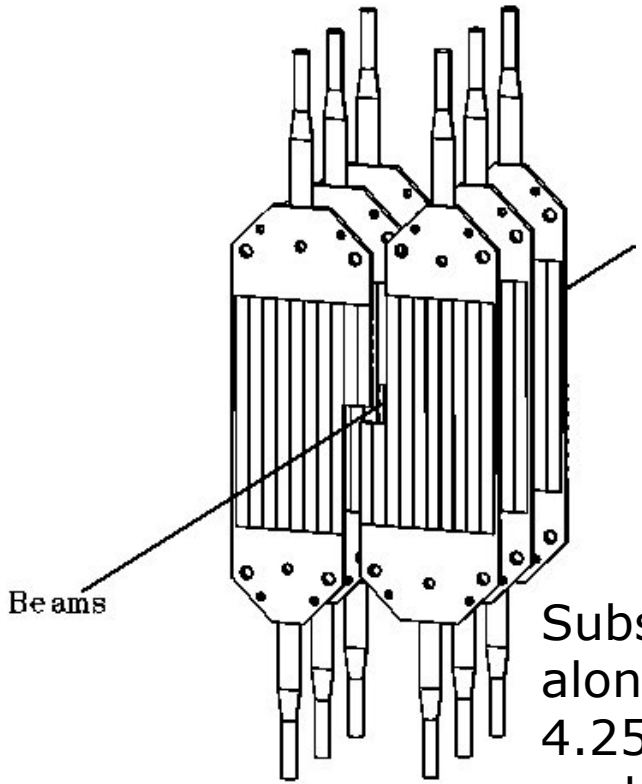



- Acceptance angle 300x300 mrad$^2$
- Pixels lie 6 mm from beam line during operation
- Pixels moved 20 mm away from beam during injection, 1 cycle every 24 hrs
- Alignment <50μm, reproducible < 50μm, stability < 2μm
- Material budget – X0=1.25% per plane in active area
- RF shield required for adequate impedance

# Pixel Station

Substrates move horizontally for beam injection

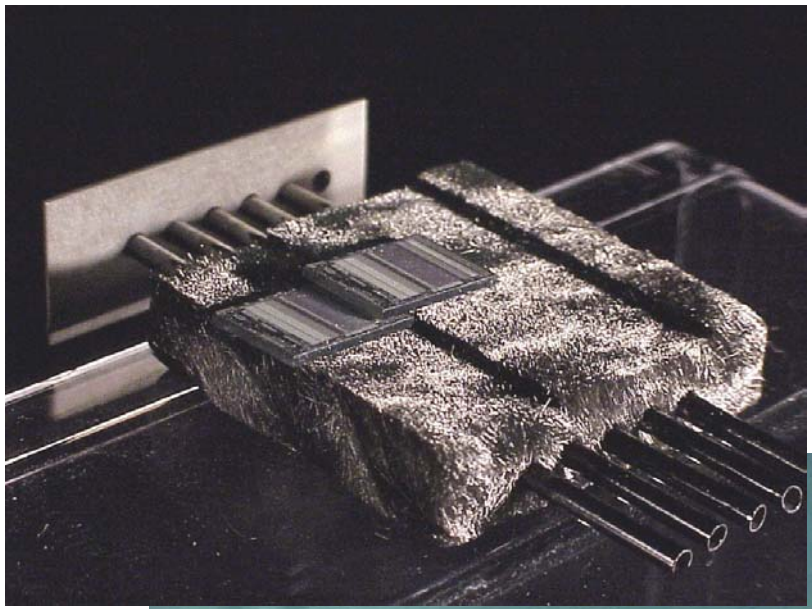


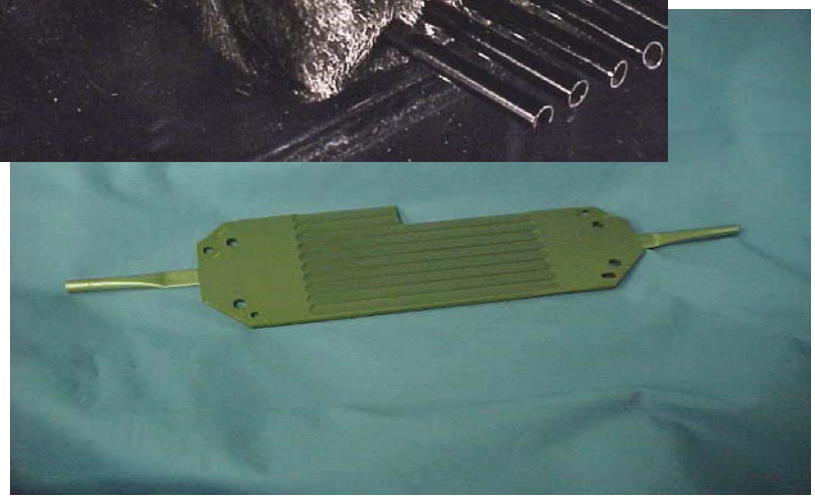




Substrates offset along beam 4.25 cm from each other

- Pixels reside on substrates
- 2 substrates per station, 30 stations total
- Shingled design for full coverage

# Substrate Material

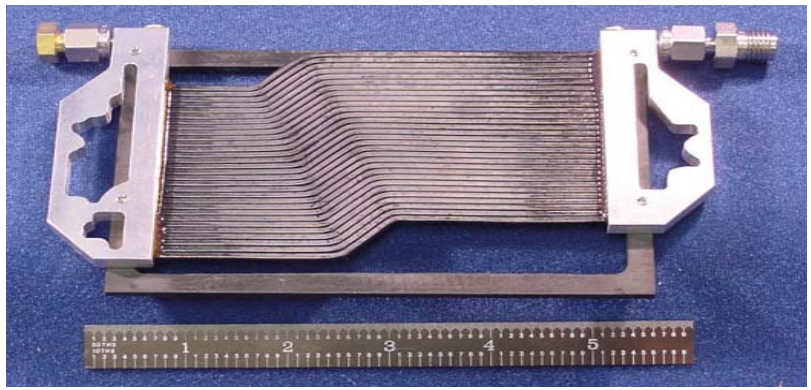


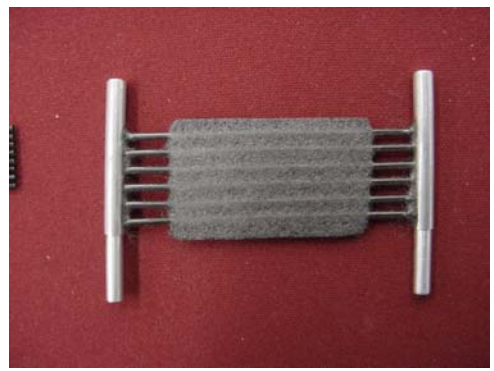


- "Fuzzy carbon" material (ESLI, San Diego, CA) - baseline
  - Carbonized fibers
  - Material X0=0.02% for t=0.88mm
  - Matching CTE w/ silicon
  - Single vendor
- Beryllium – more robust
- Pocofoam
  - Graphite foam - another carbon-based composite

# Cooling System

- Water glycol coolant (40% glycol by volume)
- Coolant flow rate 1 L/min through each substrate
- Cooling lines made of glassy carbon tubes
- Cooling lines embedded within fuzzy carbon substrate





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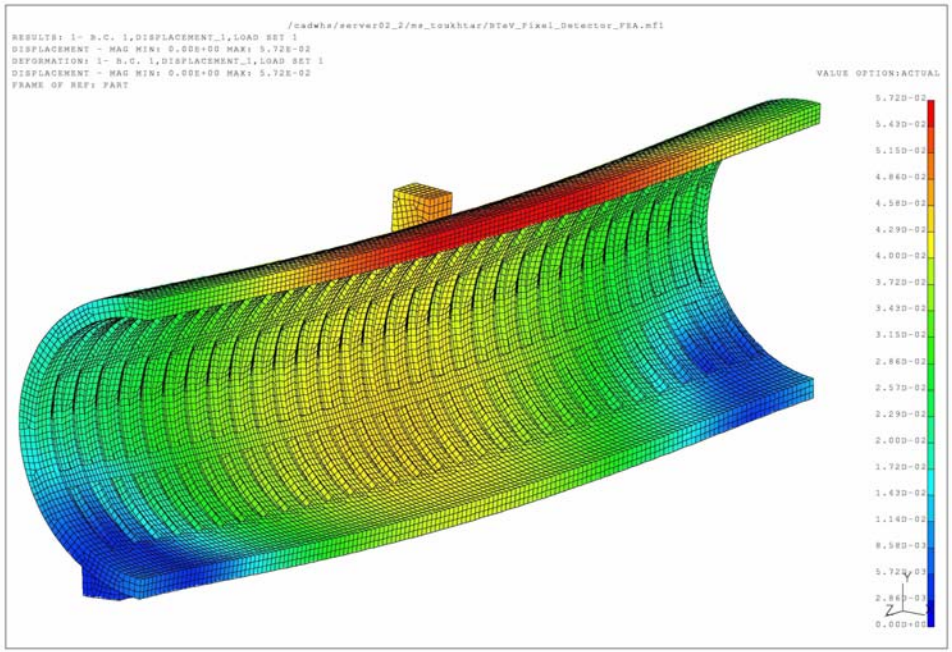
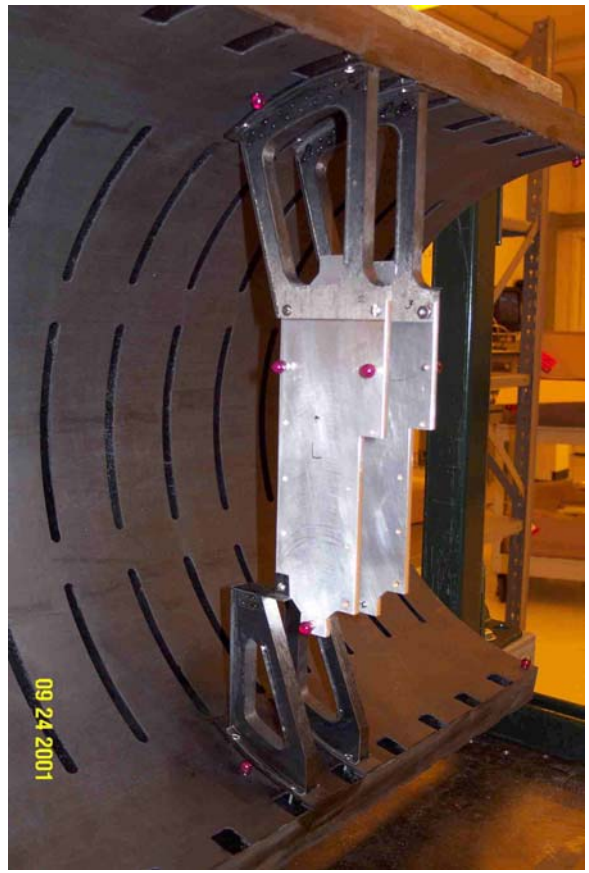
# Support Structure

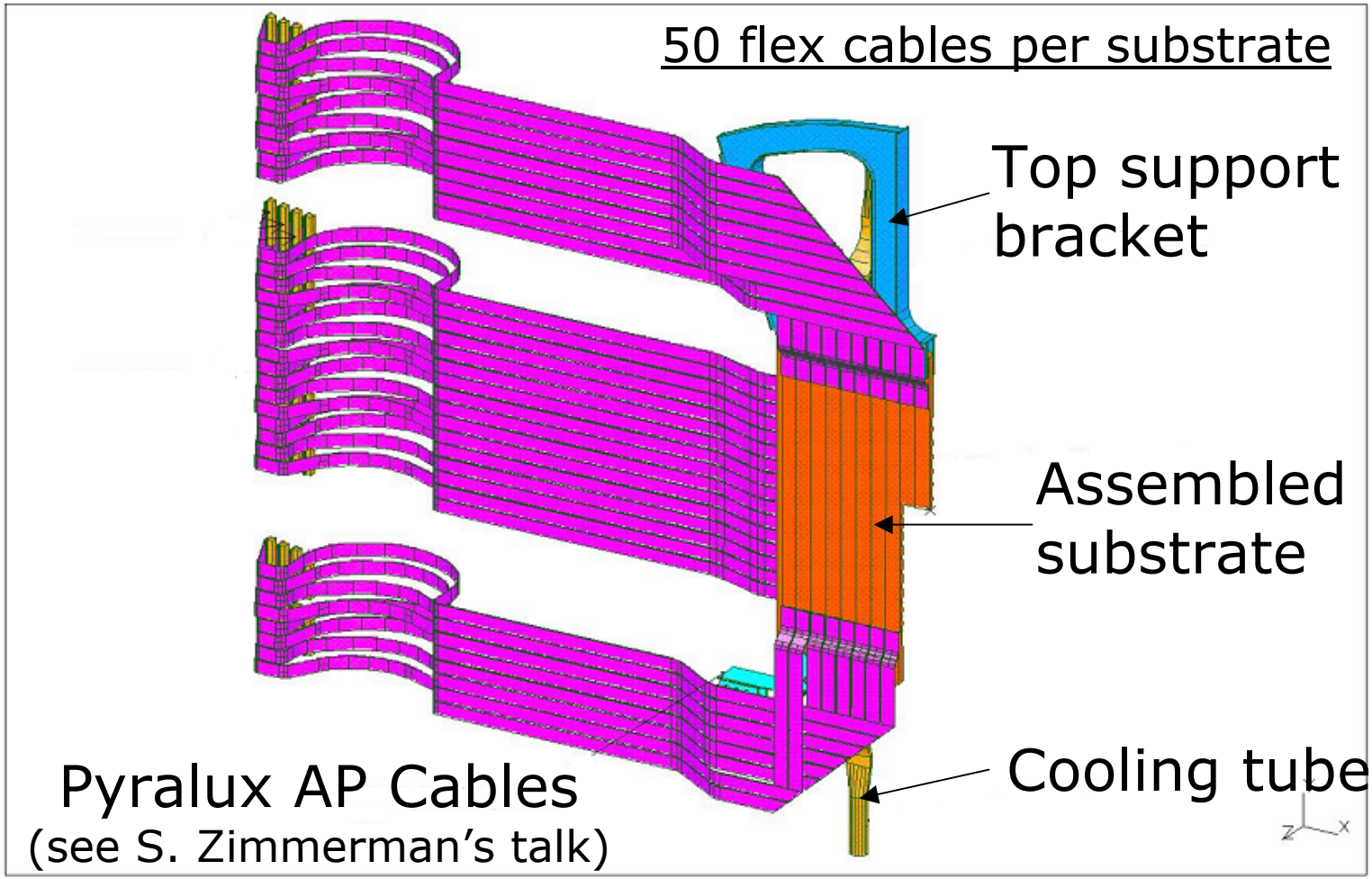


FEA of half cylinder showing max displacement 0.057mm when loaded with its mass and mass of substrate assemblies

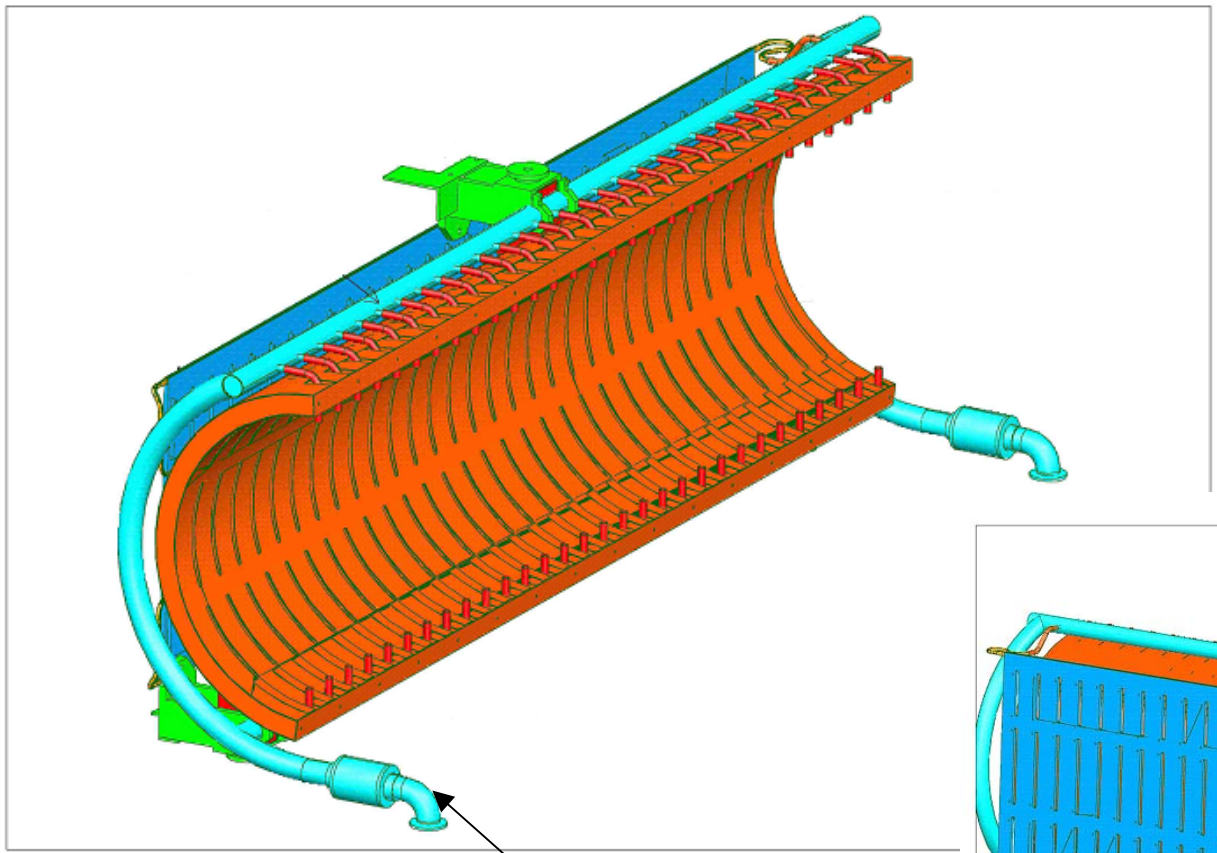



Carbon fiber half cylinder holding substrates (aluminum only for prototype) with carbon fiber brackets

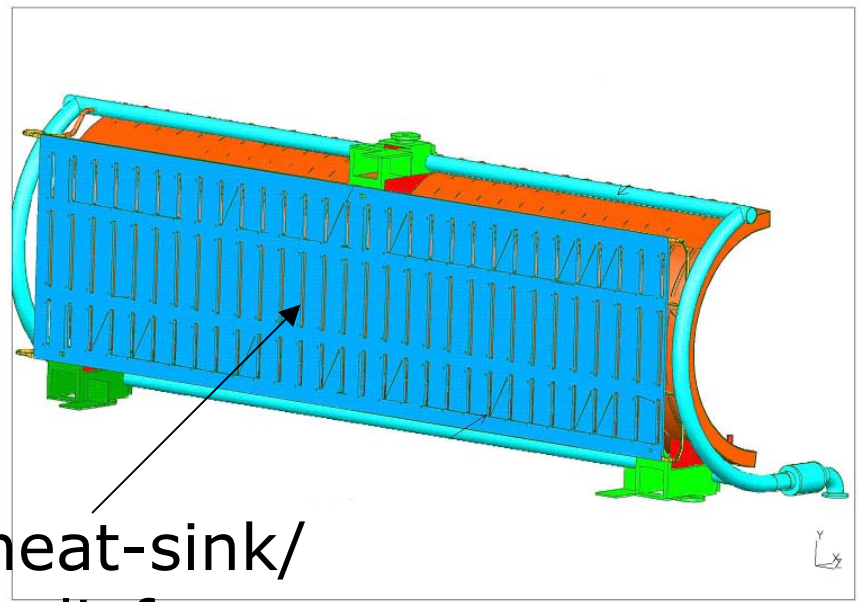
# Pyralux Flex Cables



# Assembly of Half cylinder

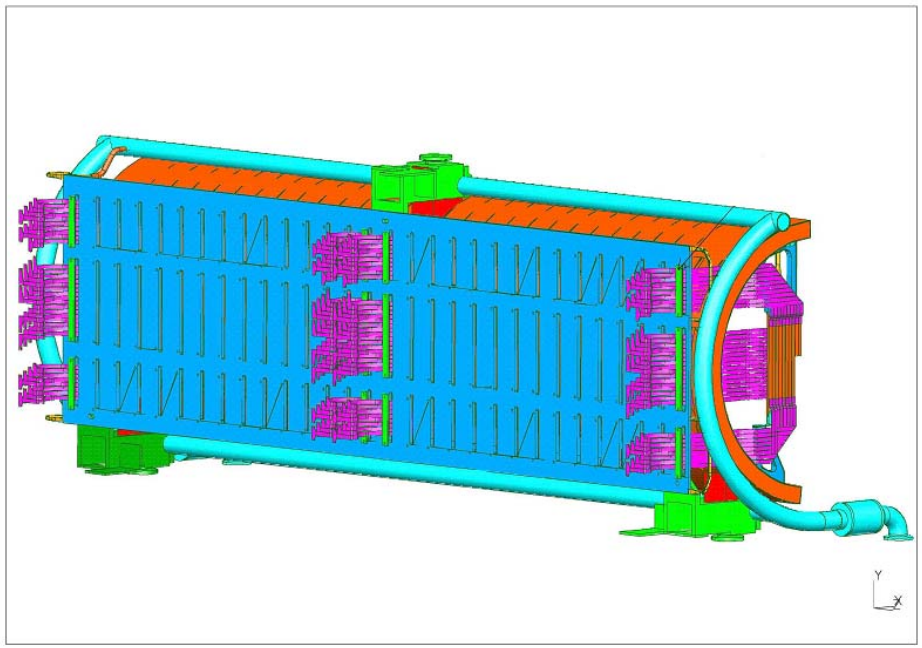


Main cooling manifold



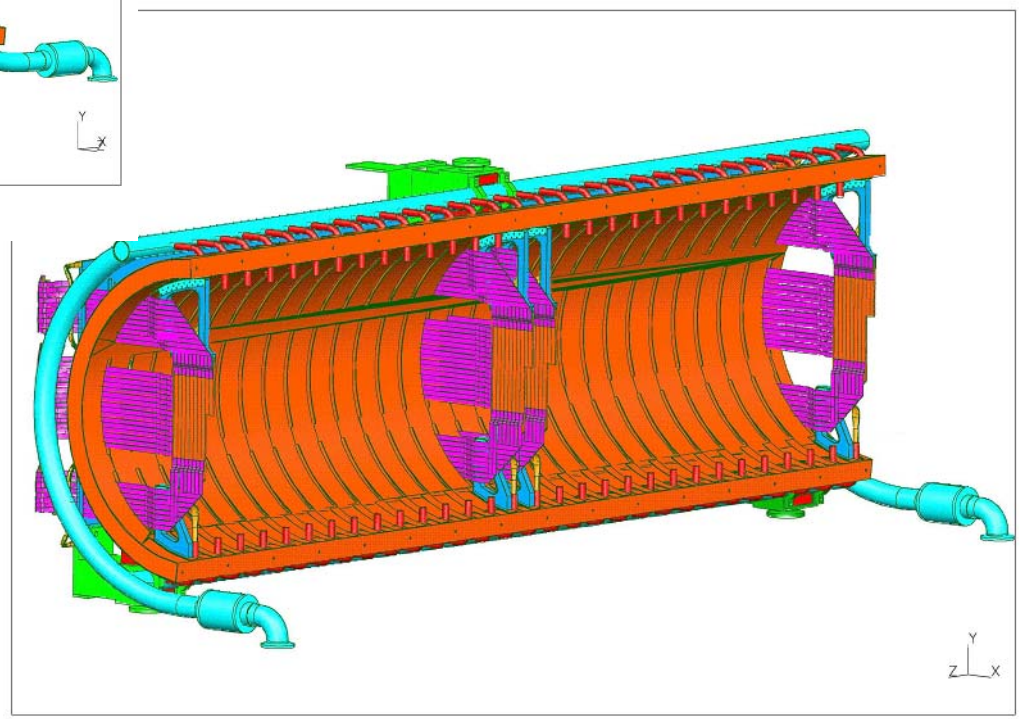
Cable heat-sink/
Strain relief

# 4 Substrates Installed



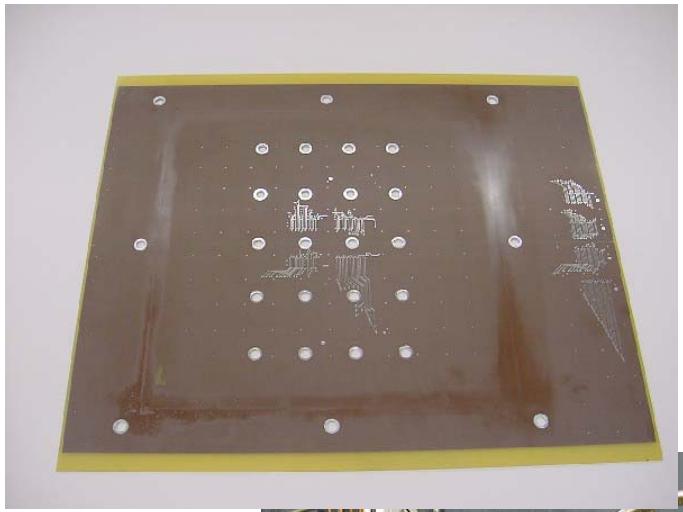
X0=0.17%
for fuzzy carbon substrate,
glassy carbon tubing,
and water glycol coolant
in active area

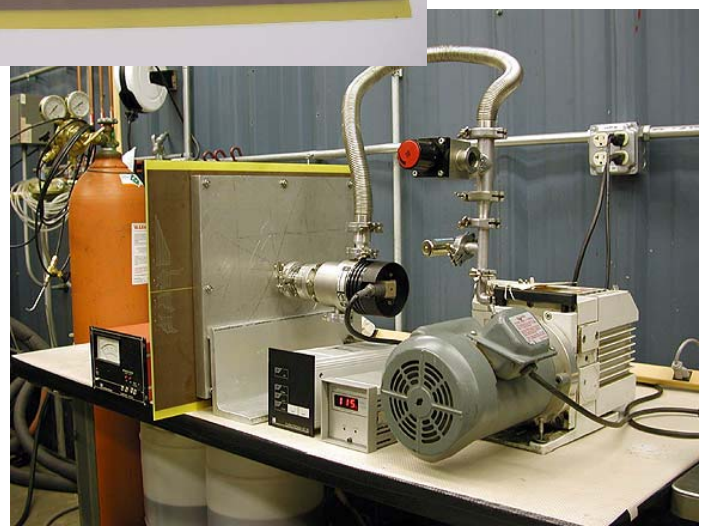
Cables clamped to strain relief/heat sink

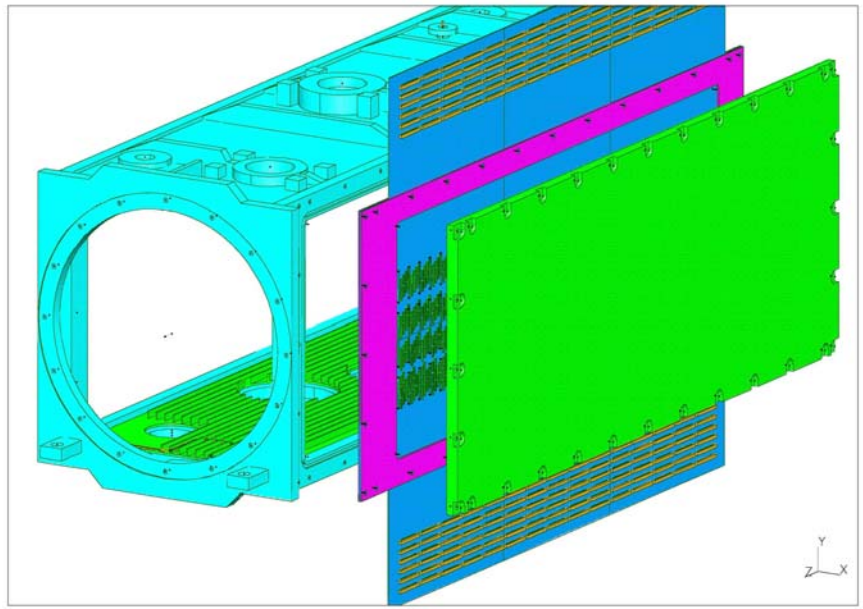


# Electrical Feedthrough Board

Each FTB holds 1500 cables





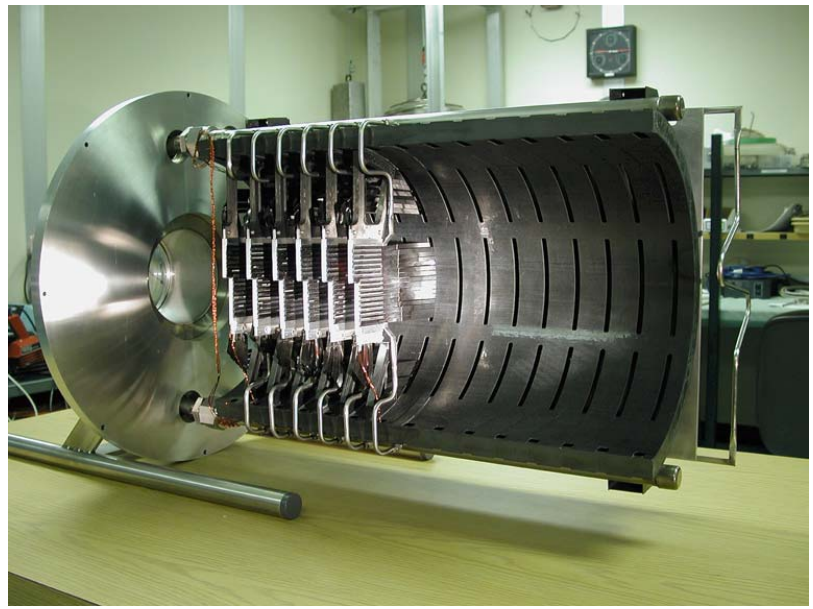


View of one feedthrough board on vessel

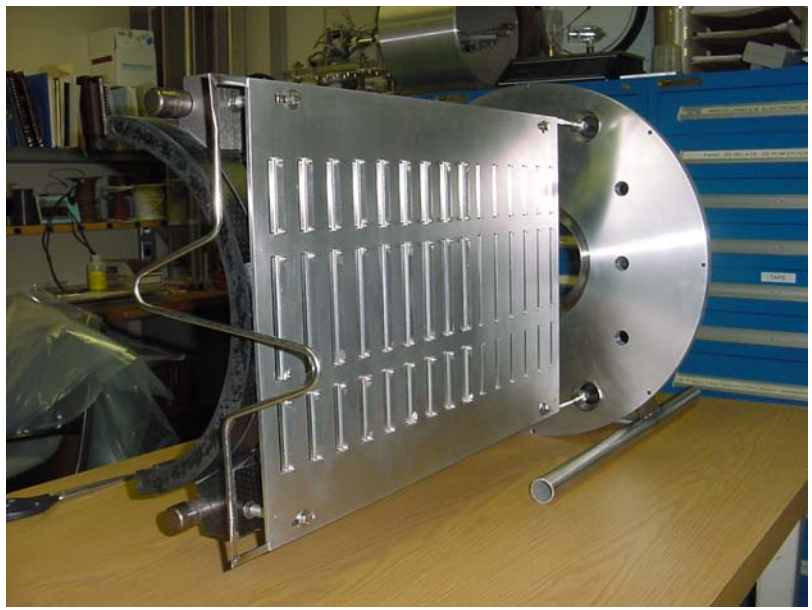
Seal of PCB leak tight (1e-10 std-cc/sec for He)

# 5% Model

- 5% model built
  - 6 substrates with dummy modules and cables (10% of total)
  - "Cables" clamped to aluminum plate
  - 5% of total surface area
- Substrates and aluminum plate cooled independently of each other
- Gas load measured at various temperatures



# Vacuum System for 5% Model



- Cooling aluminum panel to –160°C resulted in vacuum pressure ~$10^{-9}$ torr (regardless of substrate temperature)
- Cryopanel allows detector to reside in single vacuum chamber ($H_2O$ pump speed 19,000 L/sec)
- Additional pumping by turbo pumps ($N_2$ 1300 L/sec)

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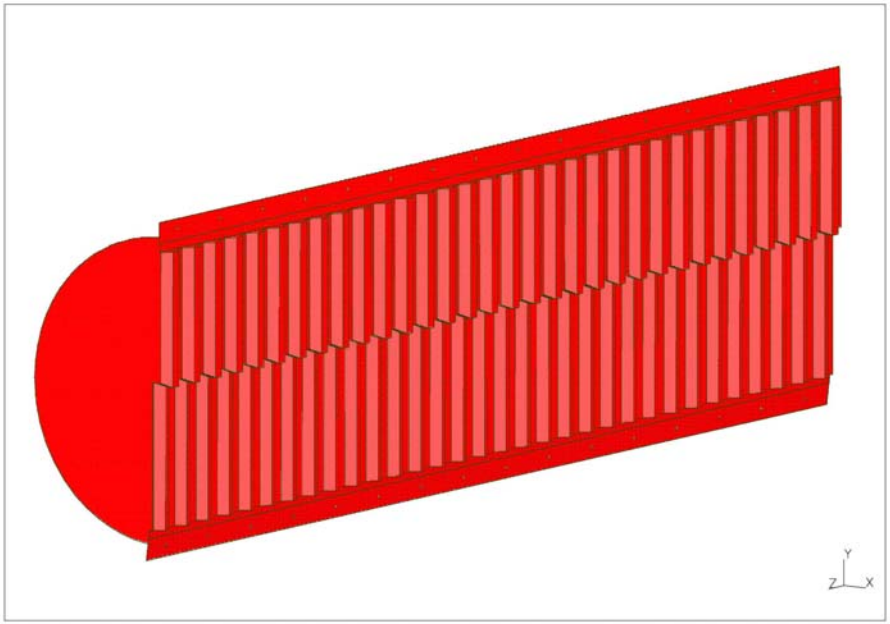
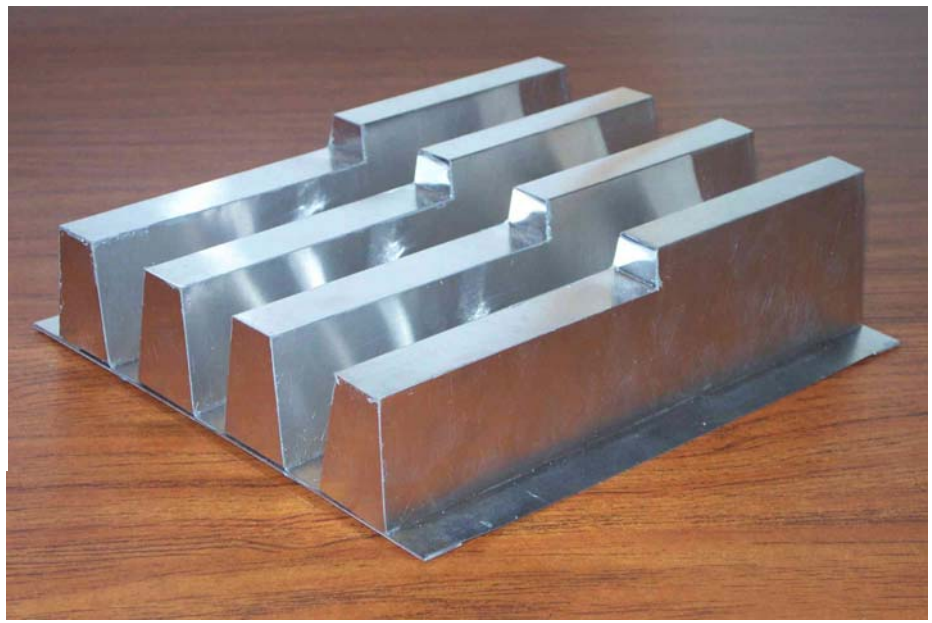
# RF shield



aluminum 0.25 mm thick



- Baseline design - corrugated RF shield
- Leak-tight shield not needed

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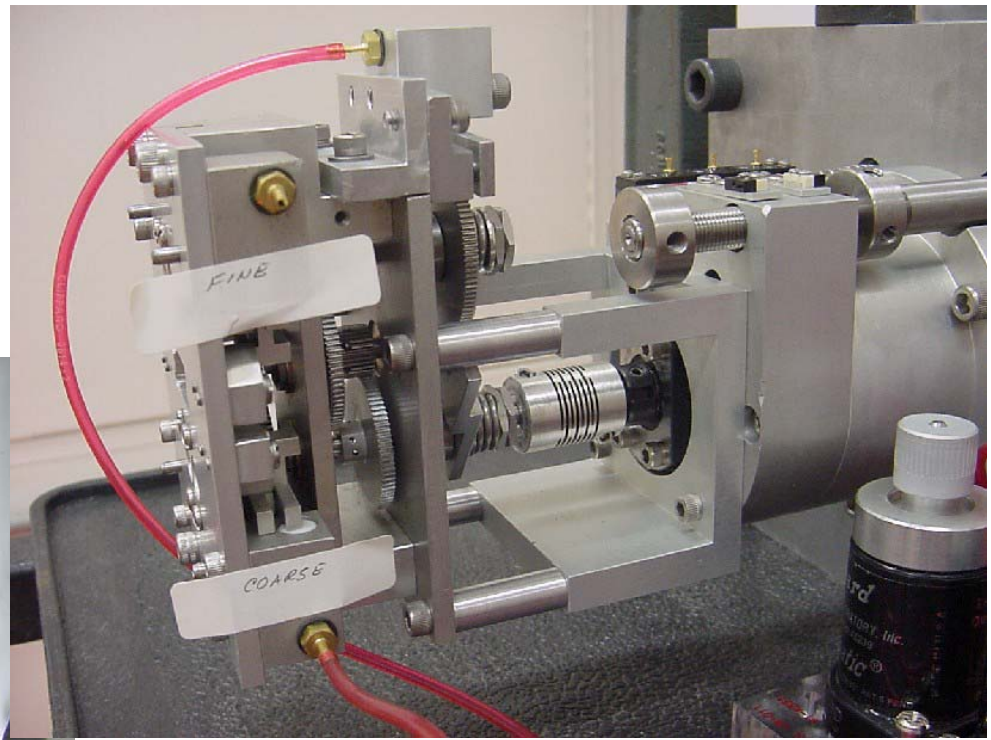
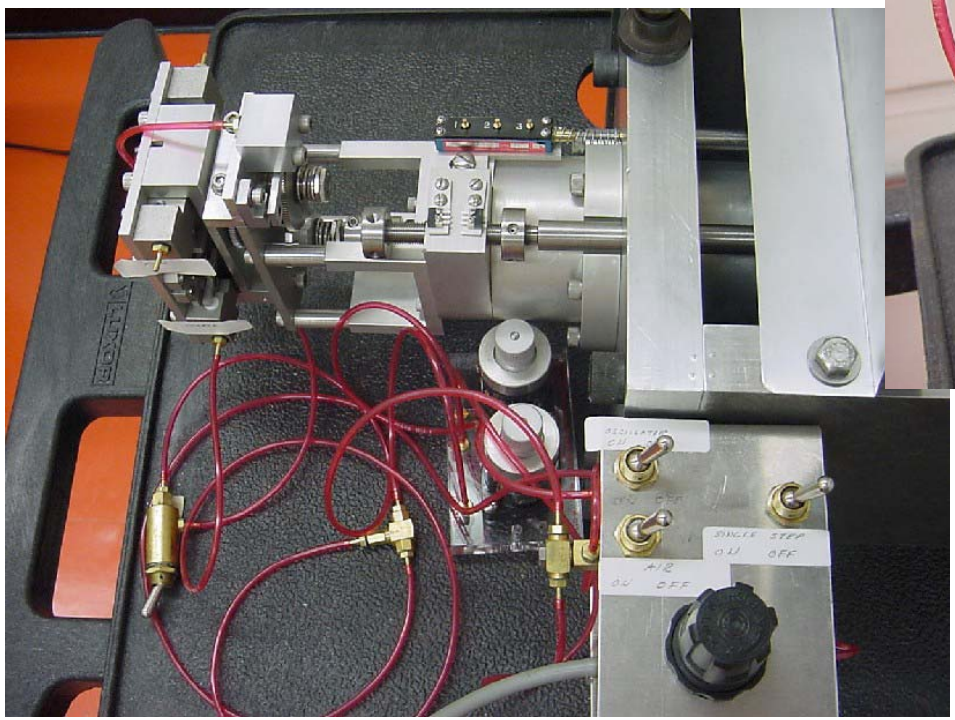
# Prototype Actuator

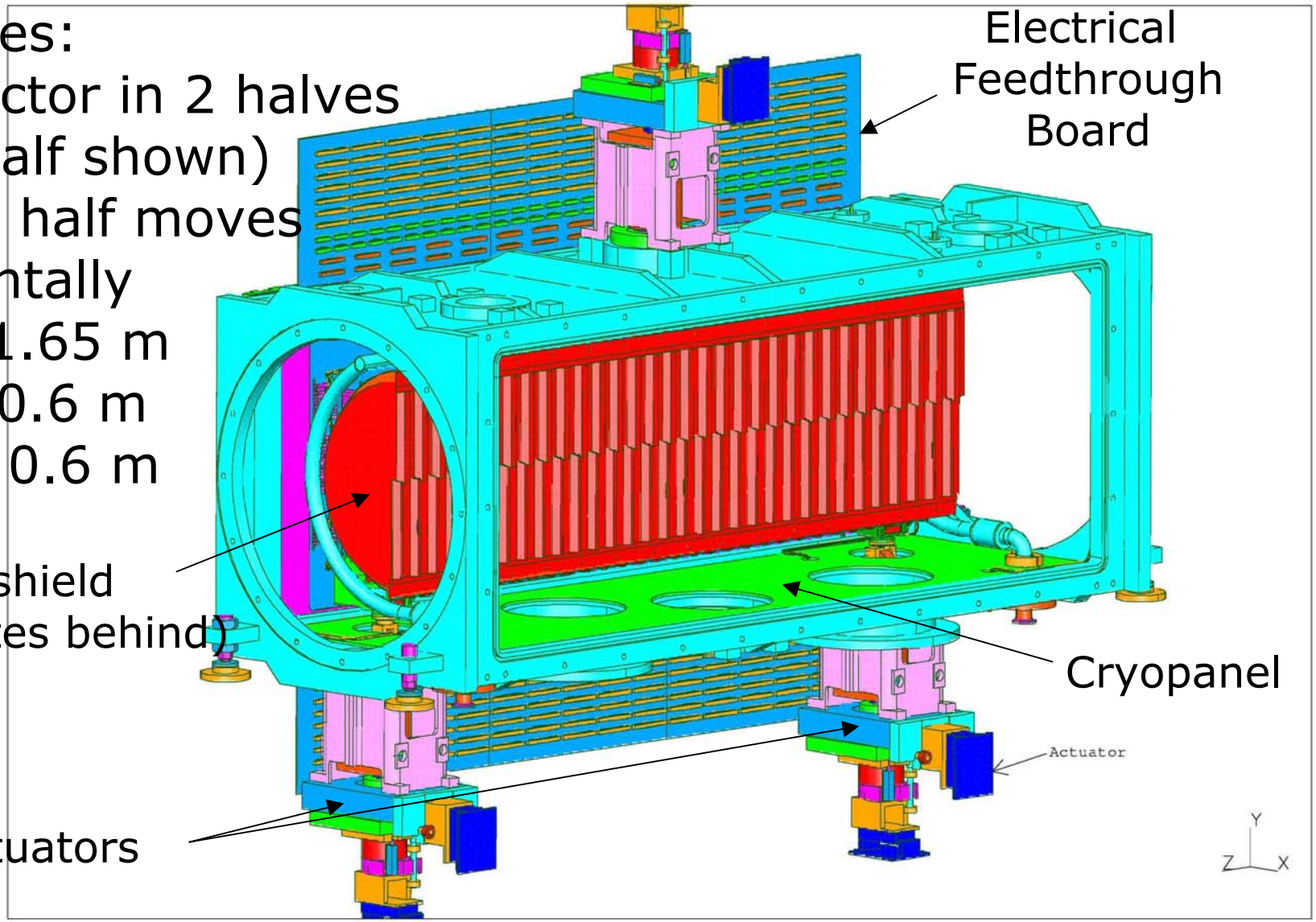
- Step sizes 1 & 10 μm
- 4 minutes to move 2cm
- Air controlled



Features:

- Detector in 2 halves (one half shown)
- Each half moves horizontally
- L = 1.65 m
- H = 0.6 m
- W = 0.6 m

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# New Development Steps

- Study and understand EMI issues
- Design new format of RF shield (wires? mesh?) by working with Beams Division
- Assemble large, leak-tight feedthrough board (1.65 m in length)
- Combine cryopanel and substrate cooling systems to cool pixels to –10°C